TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3313

Chopper Regulator and DC-DC Converter Applications Motor Drive Applications

• Fast reverse recovery time : t_{rr} = 90 ns (typ.)

• Built-in high-speed free-wheeling diode

• Low drain-source ON-resistance : $R_{DS(ON)} = 0.5 \Omega$ (typ.)

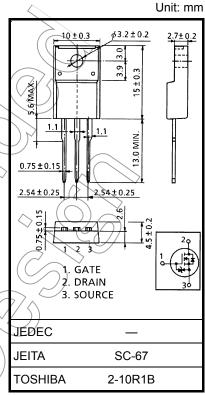
High forward transfer admittance : |Y_{fs}| = 8.5 S (typ.)

• Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 500 V)

Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

| | | | | IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII |
|-------------------------|------------------------|-------------------------|------------|--------------------------------------|
| Characteris | etics | Symbol | Rating | Unit |
| Drain-source voltage | | V_{DSS} | 500 | У |
| Drain-gate voltage (Ro | _{SS} = 20 kΩ) | V_{DGR} | 500 | > v |
| Gate-source voltage | | V _{GSS} | ±30 | V |
| Drain current | DC (Note 1) | I _D | 12 | A |
| | Pulse (Note 1) | I _{DP} | 48 | A |
| Drain power dissipation | r (Tc = 25°C) | PD | 40 | \\W\ |
| Single pulse avalanche | energy (Note 2) | EAS | 324 | mJ |
| Avalanche current | | (IAR \ | 12 | A |
| Repetitive avalanche e | nergy (Note 3) | EAR | 4.0 | mi |
| Channel temperature | _ ((| / /⟨ \ ch | 150 | √°C |
| Storage temperature ra | inge | | -55 to 150 | °C |



Weight: 1.9 g (typ.)

Note: Using continuously under heavy-loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

| Characteristics | Symbol | Max | Unit |
|--|------------------------|-------|--------|
| Thermal resistance, channel to case | R _{th (ch-c)} | 3.125 | °C / W |
| Thermal resistance, channel to ambient | Rth (ch-a) | 62.5 | °C / W |

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 3.83 mH, R_G = 25 Ω , I_{AR} = 12 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

Electrical Characteristics (Ta = 25°C)

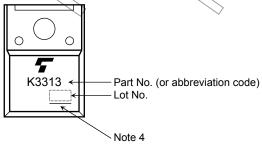
| Charac | cteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--------------------------------------|-----------------|----------------------|---|-----------|------|------|------|
| Gate leakage cu | rrent | I _{GSS} | V _{GS} = ±25 V, V _{DS} = 0 V | _ | _ | ±10 | μΑ |
| Gate-source bre | eakdown voltage | V (BR) GSS | I _G = ±100 μA, V _{DS} = 0 V | ±30 | _ | _ | V |
| Drain cut-off cui | rrent | I _{DSS} | V _{DS} = 500 V, V _{GS} = 0 V | \ <u></u> | _ | 100 | μA |
| Drain-source br | eakdown voltage | V (BR) DSS | I _D = 10 mA, V _{GS} = 0 V | 500 | | _ | V |
| Gate threshold v | oltage | V_{th} | V _{DS} = 10 V, I _D = 1 mA | 2.0 |) >_ | 4.0 | V |
| Drain-source Ol | N-resistance | R _{DS} (ON) | V _{GS} = 10 V, I _D = 6 A | <u> </u> | 0.5 | 0.62 | Ω |
| Forward transfer | admittance | Y _{fs} | V _{DS} = 10 V, I _D = 6 A | 3.0 | 8.5 | _ | S |
| Input capacitano | e | C _{iss} | | | 2040 | _ | |
| Reverse transfer | r capacitance | C _{rss} | V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz | ^ — | 210 | _ | pF |
| Output capacitar | nce | Coss | | _ | 630 | _ | |
| Switching time | Rise time | tr | V_{GS} V_{OUT} V_{GS} V_{OUT} V_{OUT} V_{OUT} V_{OUT} V_{OUT} | - (| 22 | > | |
| | Turn-on time | t _{on} | | | 58 |) _ | |
| | Fall time | t _f | | 7 | 36 | _ | ns |
| | Turn-off time | t _{off} | $V_{DD} = 200V$ Duty $\leq 1\%$, $t_{w} = 10 \mu s$ |) – | 180 | _ | |
| Total gate charg plus gate-drain) | | Qg | | | 45 | | |
| Gate-source cha | arge | Q _{gs} | $V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, V_{D} = 12 \text{ A}$ | _ | 25 | _ | nC |
| Gate-drain ("mil | ler") charge | Qgd | | _ | 20 | _ | |

Source-Drain Ratings and Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|------------------|---|-----|------|------|------|
| Continuous drain reverse current (Note 1) | 1 _{DR} | | _ | _ | 12 | Α |
| Pulse drain reverse current (Note 1) | I _{DRP} | - | _ | _ | 48 | Α |
| Forward voltage (diode) | V _{DSF} | I _{DR} = 12 A, V _{GS} = 0 V | _ | _ | -1.7 | V |
| Reverse recovery time | t _{rr} | I _{DR} = 12 A, V _{GS} = 0 V | 1 | 90 | 160 | ns |
| Reverse recovery charge | Qrr | dl _{DR} / dt = 100 Å / μs | - | 0.25 | | μC |

2

Marking

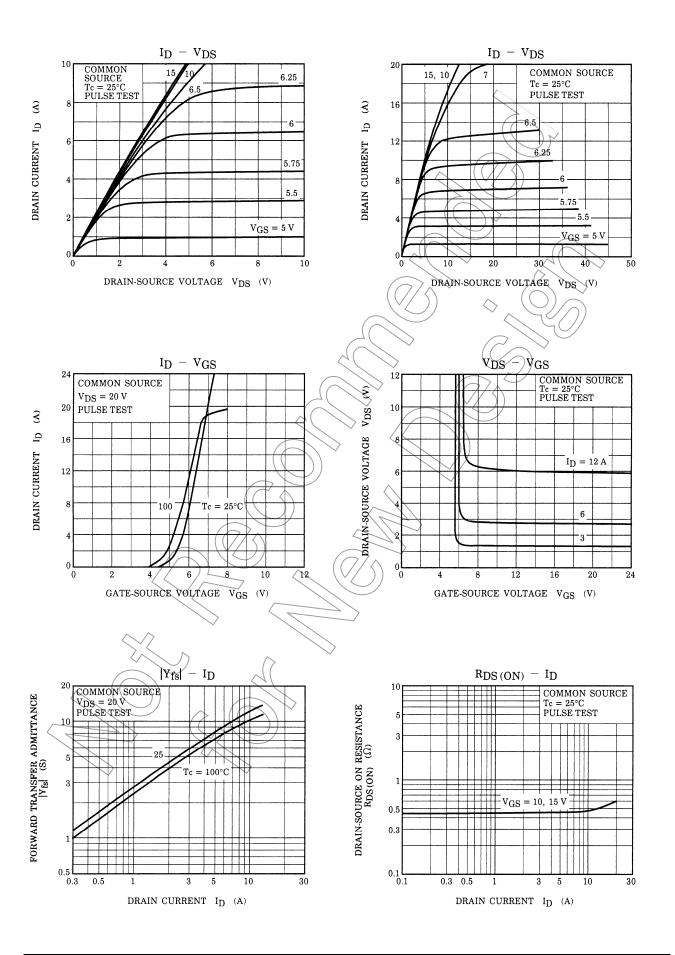


Note 4: A line under a Lot No. identifies the indication of product Labels.

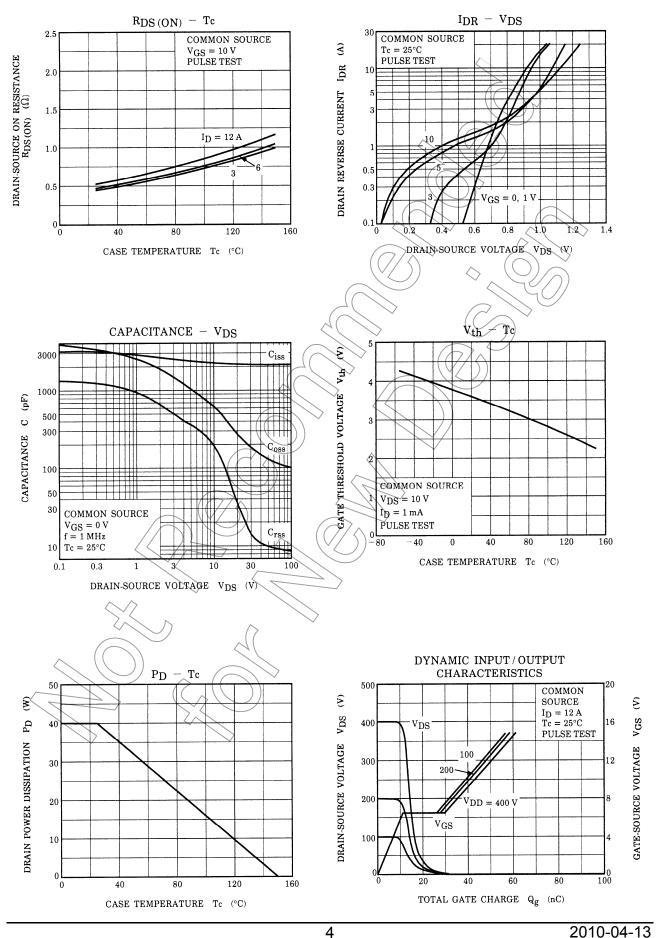
Not underlined: [[Pb]]/INCLUDES > MCV

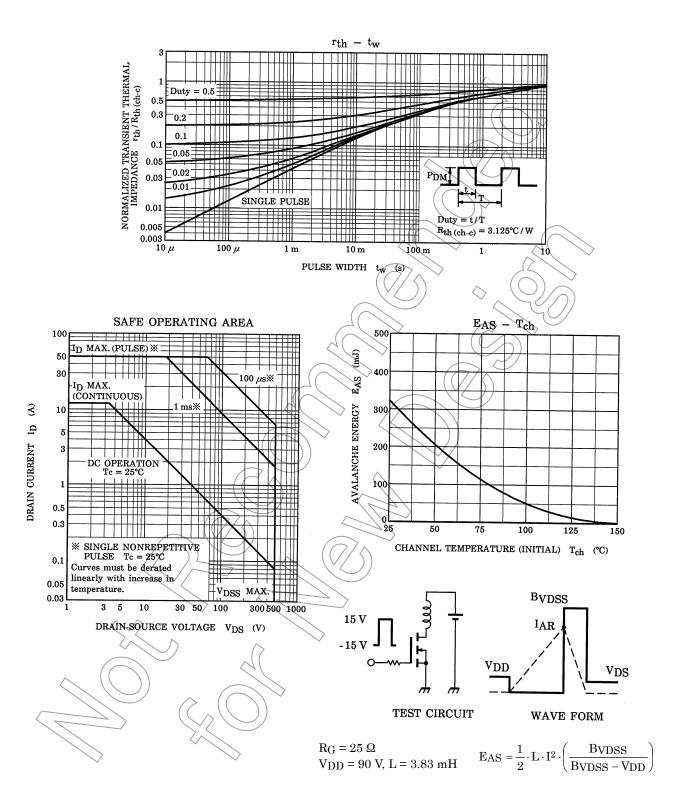
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



3 2010-04-13





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